

FM3L40-ASF-Q1 THRU FM3L100-ASF-Q1

List

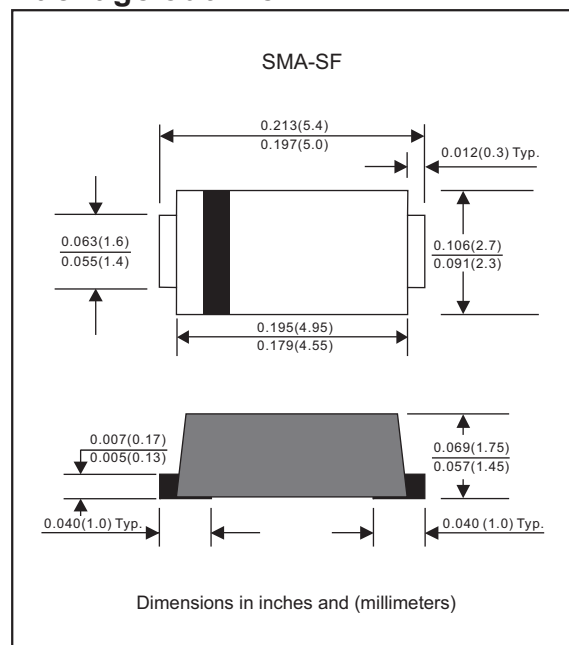
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FM3L40-ASF-Q1 THRU FM3L100-ASF-Q1**3.0A Low VF Surface Mount Schottky
Barrier Rectifiers 40V-100V****Features**

- High current density schottky
- Low profile surface mounted application in order to optimize board space
- Low power loss, high efficiency
- High current capability, low forward voltage drop
- High surge capability
- Lead-free parts meet RoHS requirements
- Qualified to AEC-Q101 standards for high reliability
- Suffix "-H" indicates Halogen free parts, ex. FM3L40-ASF-Q1-H

Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, SMA-SF
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any
- Weight : Approximated 0.04 gram

Package outline**Maximum ratings** (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	FM3L40-ASF-Q1	FM3L45-ASF-Q1	FM3L60-ASF-Q1	FM3L100-ASF-Q1	UNITS
Maximum repetitive peak reverse voltage	VRRM	40	45	60	100	Volts
Maximum RMS voltage	VRMS	28	31.5	42	70	Volts
Maximum continuous reverse voltage	VR	40	45	60	100	Volts
Maximum average forward rectified current	IO	3.0				Amps
Non-repetitive peak forward surge current 1.0ms square-wave	IFSM	80				Amps
Operating junction temperature range	TJ	-55 to +125		-55 to +150		°C
Storage temperature range	TSTG	-65 to +175				°C

Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	FM3L40-ASF-Q1	FM3L45-ASF-Q1	FM3L60-ASF-Q1	FM3L100-ASF-Q1	UNITS
Maximum instantaneous forward voltage at $I_F=3.0A$	V_F	0.45		0.55	0.75	Volts
Maximum reverse leakage current at rated V_R $T_J=25^\circ\text{C}$ $T_J=100^\circ\text{C}$	I_R	0.5 20				mA mA

Thermal characteristics

PARAMETER	SYMBOLS	FM3L40-ASF-Q1	FM3L45-ASF-Q1	FM3L60-ASF-Q1	FM3L100-ASF-Q1	UNITS
Typical thermal resistance junction to ambient (Note 1)	$R_{\theta JA}$	64				$^\circ\text{C/W}$
Typical thermal resistance junction to case (Note 1)	$R_{\theta JC}$	28				$^\circ\text{C/W}$

Note 1: Mounted on FR-4 PCB Copper, minimum recommended pad layout.

Rating and characteristic curves (FM3L40-ASF-Q1 THRU FM3L100-ASF-Q1)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

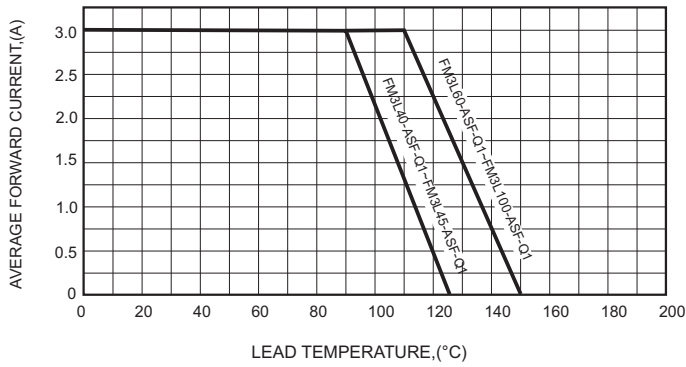


FIG.2-TYPICAL FORWARD CHARACTERISTICS

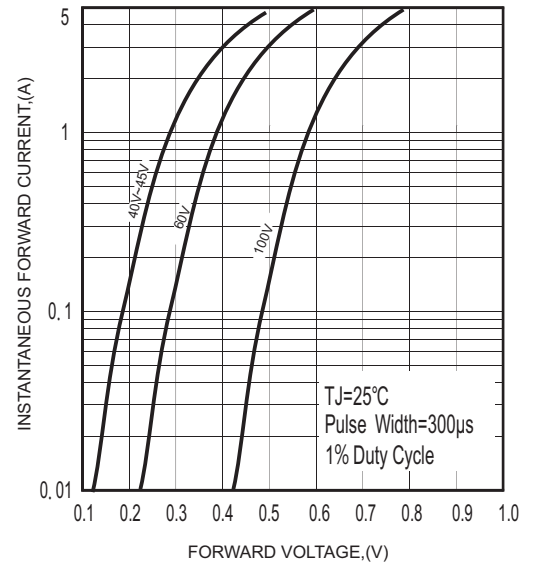


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

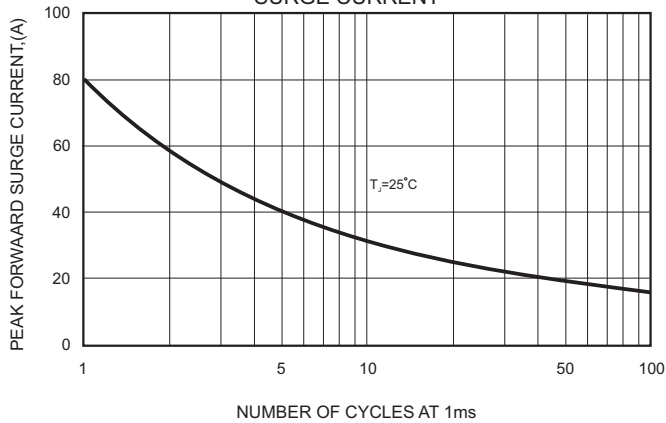


FIG.4-TYPICAL JUNCTION CAPACITANCE

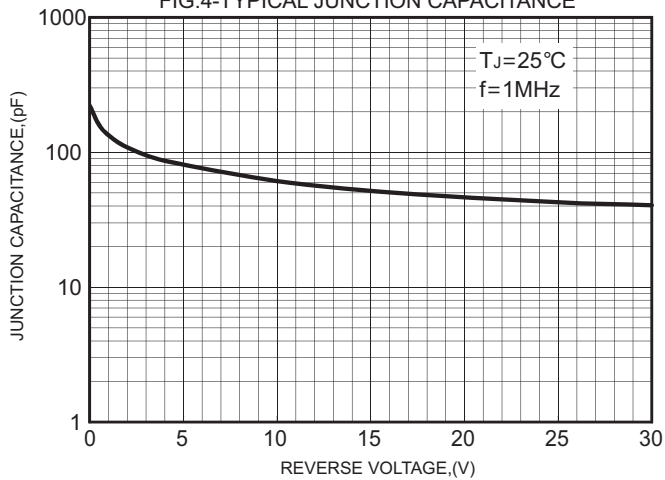
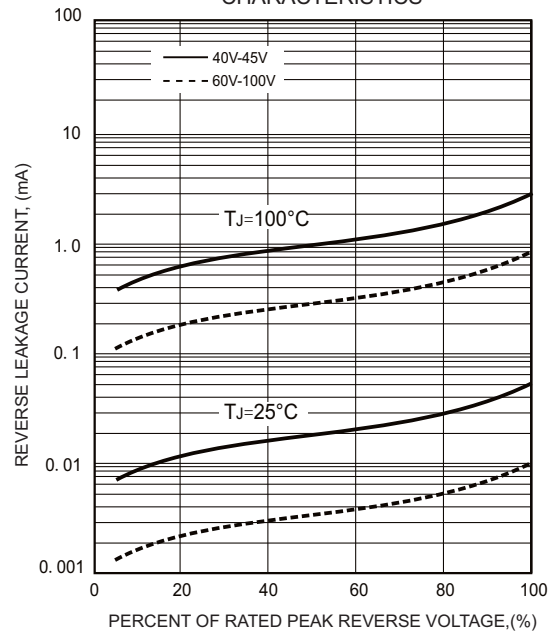


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

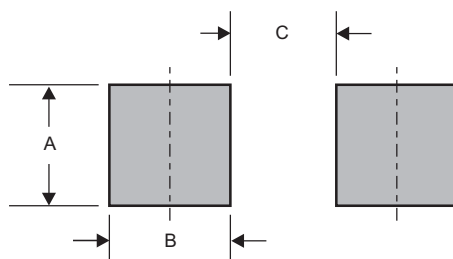


FM3L40-ASF-Q1 THRU FM3L100-ASF-Q1**Pinning information**

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code
FM3L40-ASF-Q1	3L40
FM3L45-ASF-Q1	3L45
FM3L60-ASF-Q1	3L60
FM3L100-ASF-Q1	3L100

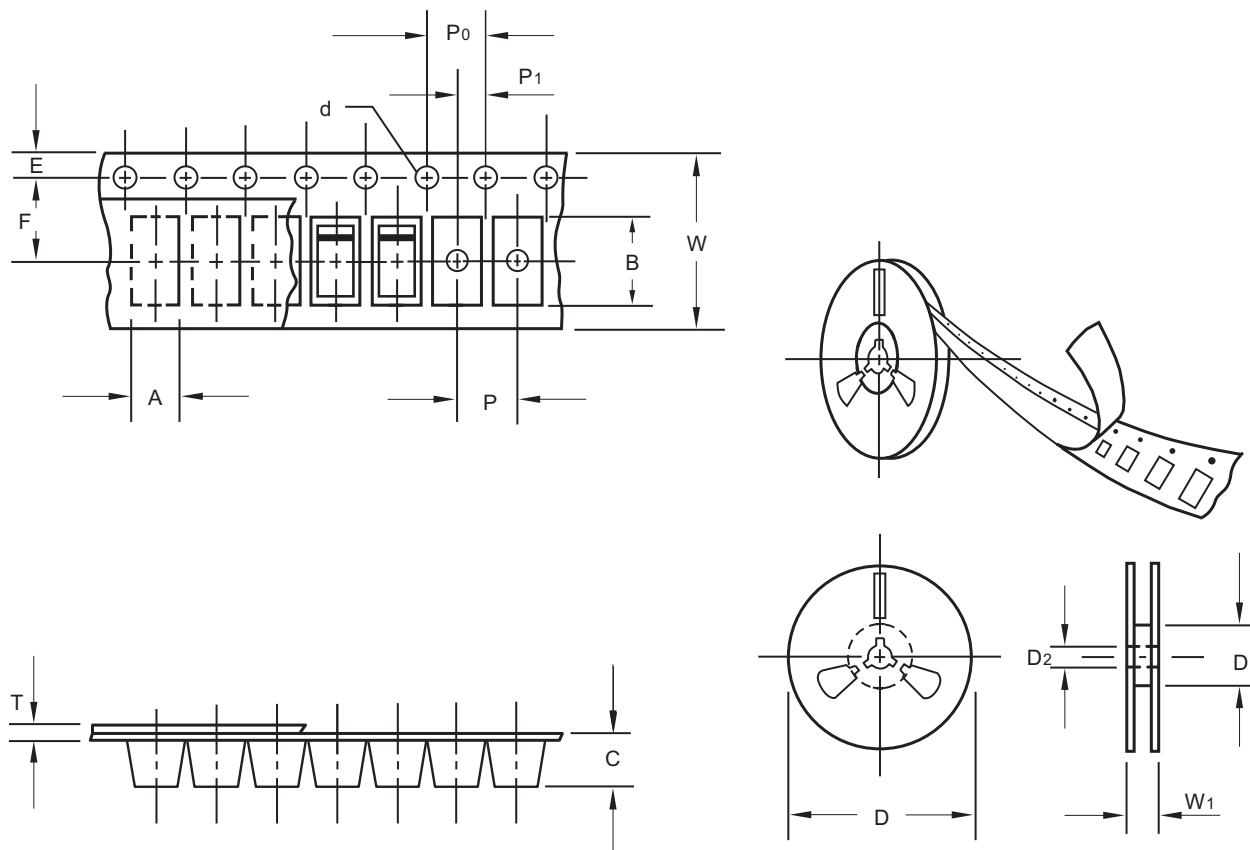
Suggested solder pad layout

Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SMA-SF	0.063 (1.60)	0.059 (1.50)	0.110 (2.80)

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Packing information



unit:mm

Item	Symbol	Tolerance	SMA-SF
Carrier width	A	0.1	2.90
Carrier length	B	0.1	5.50
Carrier depth	C	0.1	2.10
Sprocket hole	d	0.1	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D1	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	62.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.23
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.00

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

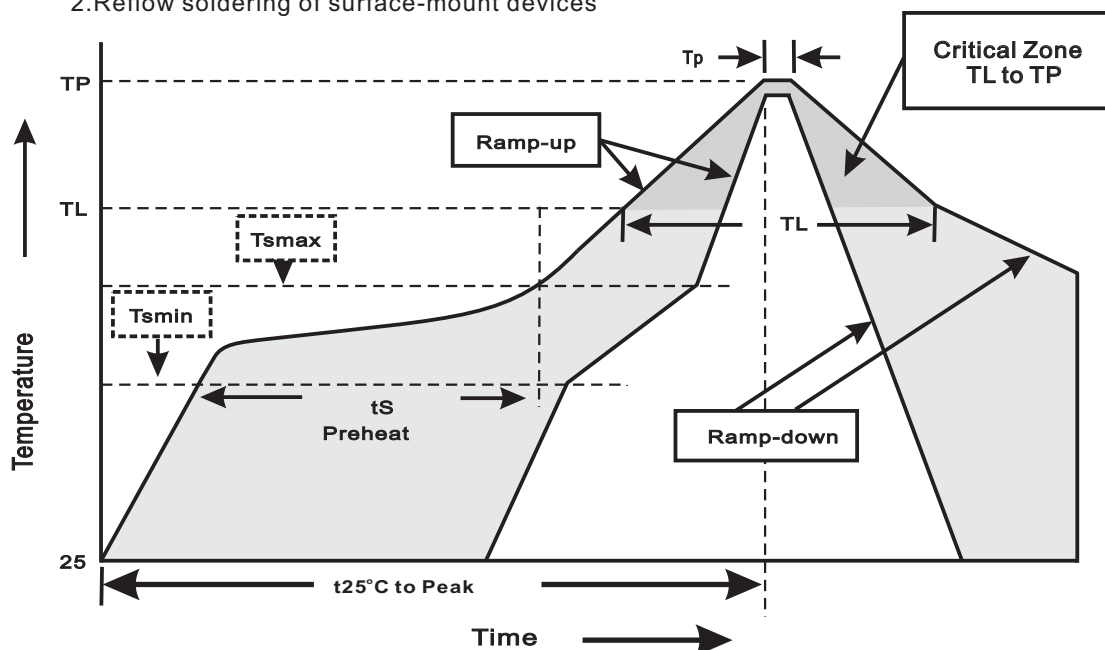
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Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMA-SF	7"	2,000	4.0	20,000	183*155*183	178	382*356*392	160,000	12.0
	13"	7,500	4.0	15,000	335*335*38	330	350*330*360	120,000	11.5

Suggested thermal profiles for soldering processes

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T _L to T _P)	<3°C/sec
Preheat -Temperature Min(T _{smin}) -Temperature Max(T _{smax}) -Time(min to max)(t _s)	150°C 200°C 60~120sec
T _{smax} to T _L -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(T _L) -Time(t _L)	217°C 60~260sec
Peak Temperature(T _P)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t _P)	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes

FM3L40-ASF-Q1 THRU FM3L100-ASF-Q1**High reliability test capabilities**

Item Test	Conditions	Reference
1. MSL Preconditioning	24hr bake@125°C+168hrs@85°C /85%RH+3xIR@260°C+1flux immersion+alcohol+DI H2O rinse	JESD22-A113
2. Operation Life	Ta=25°C,Rated Current (Io=Io max.)Test Duration:1000hrs	MIL-STD-750E METHOD 1027.3
3. High Temperature Reverse Bias	80% Rated VR (Tj=Tj max.)Test Duration:1000hrs	JESD22-A108
4. High Temperature Storage Life	Ta=125°C Test Duration:1000hrs	JESD22 A-103
5. Temperature Cycle	-55°C(15min) to 150°C(15min)Test Cycles:1000cycles	JESD22 A-104
6. Autoclave	P=2atm Ta=121°C RH=100% Test Duration:96hrs	JESD22 A-102
7. Intermittent Operational Life	Ta=25°C,On/Io Max. 2min, Off/2min, Test Cycles:15000cycles	MIL-STD-750E METHOD 1037
8. Solderability	245±5°C for 5sec	J-STD-002
9. Moisture Resistance	Ta=85°C/85% Relative humidity Test Duration:1000hrs	MIL-STD-750E METHOD 1021.2
10. Resistance To Solder Heat	260±5°C for 10sec	JESD22 B-106
11. High Temperature High Humidity Reverse Bias	Ta=85°C, 85%RH, with device reverse biased at 80% of rated breakdown voltage up to a maximum of 100V or limit of chamber Test Duration:1000hrs	JESD22-A101